

P. Lawrence
#131a
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ritzdorf et al.

Patent Serial No.: Semiconductor Plating System
Workpiece Support Having
Workpiece Engaging Electrode With
Pre-Conditioned Contact Face

08/940,686

Filed: September 30, 1997

Examiner: Leader, W.

1741

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Box AF, Commissioner for Patents, Washington, D.C. 20231, on the date below.

Revisie Allen
July 24, 2000
(Date)

Box AF
Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Responsive to an Office Action mailed March 14, 2000, made final, with a three month term for response, please amend the above-identified application as follows. A request for a two month extension is being submitted simultaneously. The two month extension extends the response date to August 14, 2000.

IN THE SPECIFICATION:

Please amend the specification as follows:

On page 6, line 20, amend "3-3" to --17-17--;

On page 7, line 5, amend "7-7 in Fig. 4" to --21-21 in Fig. 18--;

On page 34, line 3, amend "contracts" to --contacts--;

On page 39, line 15, amend "3-3" to --17-17--;

On page 42, line 13, amend "develop" to --develops--;

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